

# **Data Sheet**

# **Description**

KGF65A6L and MGF65A6L are 650 V Field Stop IGBTs. Sanken original trench structure decreases gate capacitance, and achieves low saturation voltage and switching losses reduction. Thus, Field Stop IGBTs can improve the efficiency of your circuit.

#### **Features**

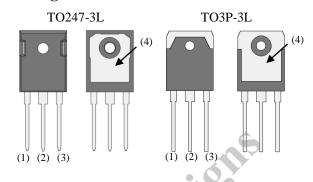
- Low Saturation Voltage
- High Speed Switching
- With Integrated Fast Recovery Diode
- RoHS Compliant

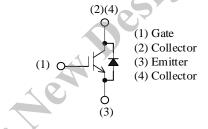
• V <sub>CE</sub>	650 V
• I <sub>C</sub> (T <sub>C</sub> = 100 °C)	60 A
• Short Circuit Withstand Time	5 μs
• V <sub>CE(sat)</sub>	1.6 V typ.
• $t_f (T_J = 175  ^{\circ}C)$	
• V <sub>F</sub>	1.7 V typ.

# **Applications**

- Uninterruptible Power Supply (UPS)
- Inverter Circuit
- Bridge Circuit

#### **Package**





(T <sub>J</sub> = 175 °C)	150 ns typ1.7 V typ.	70	(3)	(i) contector
plications ninterruptible Power Supply (UPS)		sof y		Not to scale
verter Circuit ridge Circuit	3	Selection Guide		
	20	Part Number		Package
		KGF65A6L		TO247-3L
		MGF65A6L		TO3P-3L
Aot Reconnil				

#### KGF65A6L, MGF65A6L

#### **Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25$  °C

Parameter	Symbol	Conditions	Rating	Unit	Remarks
Collector to Emitter Voltage	$V_{CE}$		650	V	
Gate to Emitter Voltage	$V_{GE}$		±30	V	
Continuous Collector Current (1)	Ţ	T <sub>C</sub> = 25 °C	80 <sup>(2)</sup>	A	
Continuous Conector Current	$I_{\rm C}$	$T_C = 100  ^{\circ}C$	60	A	
Pulsed Collector Current	$I_{C(PULSE)}$	$PW \le 1 \text{ ms},$ duty cycle $\le 1\%$	180	A	
Diode Continuous Forward Current (1)	T	$T_C = 25$ °C	80 <sup>(2)</sup>	A	
Diode Continuous Forward Current	$ m I_F$	T <sub>C</sub> = 100 °C	60	A	5
Diode Pulsed Forward Current	I <sub>F(PULSE)</sub>	$PW \le 1 \text{ ms},$	180	Α	
Blode I dised I of ward Carrent	*F(PULSE)	duty cycle ≤ 1%	100	A	
Maximum Collector–Emitter dv/dt	dv/dt	$T_J \le 175$ °C, see Figure 1.	10	V/ns	
Short Circuit Withstand Time	$t_{ m SC}$	$V_{GE} = 15 \text{ V},$ $V_{CE} = 400 \text{ V}$ $T_{J}=175 ^{\circ}\text{C}$	5	μs	
Power Dissipation	$P_D$	$T_C = 25  ^{\circ}C$	405	W	
Operating Junction Temperature	$T_{J}$		7 175	°C	
Storage Temperature Range	$T_{STG}$		−55 to 150	°C	

#### **Thermal Characteristics**

Unless otherwise specified,  $T_A = 25$  °C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Remarks
Thermal Resistance of IGBT (Junction to Case)	$R_{\theta JC}(IGBT)$		_	_	0.37	°C/W	
Thermal Resistance of Diode (Junction to Case)	$R_{\theta JC}(Di)$			_	0.93	°C/W	
AotRec							

 $<sup>^{(1)}</sup>$   $I_C$  and  $I_F$  are determined by the maximum junction temperature for TO3P-3L package.  $^{(2)}$  Determined by bonding wires capability.

# KGF65A6L, MGF65A6L

#### **Electrical Characteristics**

Unless otherwise specified,  $T_A = 25$  °C

Parameter Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector to Emitter Breakdown Voltage	V <sub>(BR)CES</sub>	$I_C = 100 \ \mu A, \ V_{GE} = 0 \ V$	650		_	V
Collector to Emitter Leakage Current	$I_{CES}$	$V_{CE} = 650 \text{ V}, V_{GE} = 0 \text{ V}$	_	_	100	μΑ
Gate to Emitter Leakage Current	$I_{GES}$	$V_{GE} = \pm 30 \text{ V}$	_		±500	nA
Gate Threshold Voltage	V <sub>GE(TH)</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ mA}$	4.0	5.5	7.0	V
Collector to Emitter Saturation Voltage	V <sub>CE(sat)</sub>	$V_{GE} = 15 \text{ V}, I_{C} = 60 \text{ A}$	—	1.6	1.96	V
Input Capacitance	$C_{ies}$	$V_{CE} = 20 \text{ V},$	_	3500	43	
Output Capacitance	$C_{oes}$	$V_{GE} = 0 V$ ,	_	330	<b>7</b>	pF
Reverse Transfer Capacitance	$C_{res}$	f = 1.0  MHz,		170		
Gate charge	$Q_{\mathrm{g}}$	$V_{CE} = 520 \text{ V}, I_{C} = 60 \text{ A}, $ $V_{GE} = 15 \text{ V}$		110	_	nC
Turn-On Delay Time	$t_{d(on)}$		1	50		
Rise Time	$t_{\rm r}$	<i>A</i>		70	_	
Turn-Off Delay Time	$t_{d(off)}$	$T_{\rm J} = 25  ^{\circ}{\rm C}$		130		ns
Fall Time	$t_{\mathrm{f}}$	see Figure 1.	_	60	_	
Turn-on Energy (3)	Eon	60)	_	1.7		I
Turn-off Energy	$E_{\rm off}$		_	1.4	_	mJ
Turn-On Delay Time	$t_{d(on)}$		_	50	_	
Rise Time	$t_{\rm r}$	70	_	70		
Turn-Off Delay Time	$t_{d(off)}$	$T_I = 175  ^{\circ}\text{C},$		160		ns
Fall Time	$t_{\mathrm{f}}$	see Figure 1.		150		
Turn-on Energy (3)	Eon			2.7		•
Turn-off Energy	E <sub>off</sub>			2.5		mJ
Emitter to Collector Diode Forward Voltage	$V_{\mathrm{F}}$	I <sub>F</sub> = 60 A	—	1.7	—	V
Emitter to Collector Diode Reverse Recovery Time	$t_{rr}$	$I_F = 60 \text{ A},$ $di/dt = 500 \text{ A/}\mu\text{s}$	_	65	_	ns

65

 $<sup>^{\</sup>left( 3\right) }$  Energy losses include the reverse recovery of diode.

#### **Test Circuits and Waveforms**

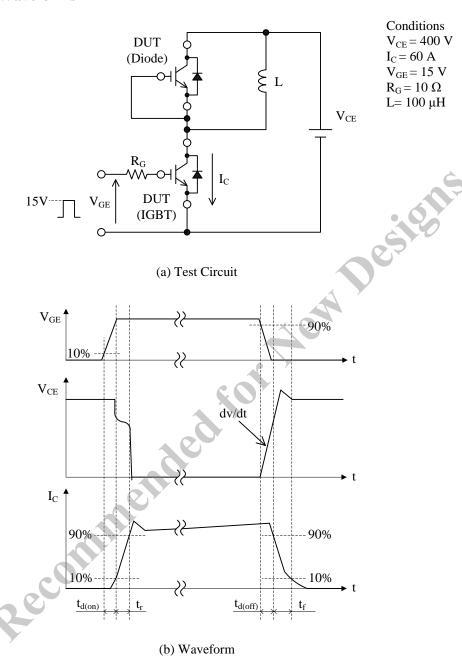


Figure 1. Test Circuits and Waveforms of dv/dt and Switching Time

#### **Rating and Characteristic Curves**

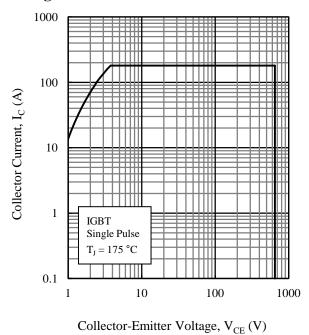


Figure 2. IGBT Reverse Bias Safe Operating Area

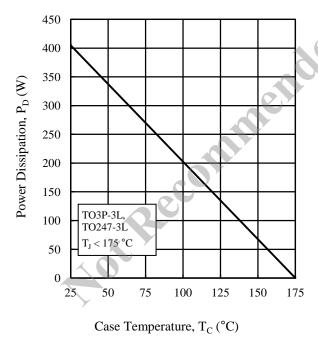


Figure 4. Power Dissipation vs. Case Temperature

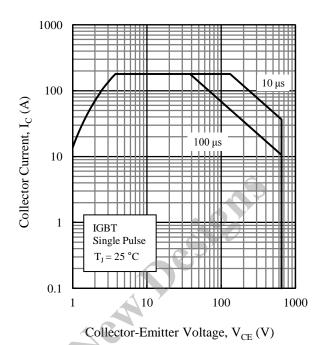


Figure 3. IGBT Safe Operating Area

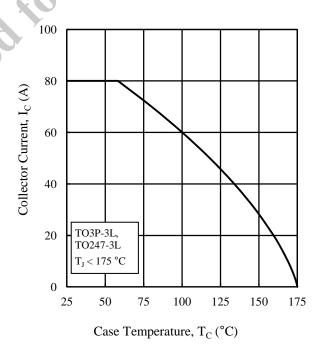


Figure 5. Collector Current vs. Case Temperature

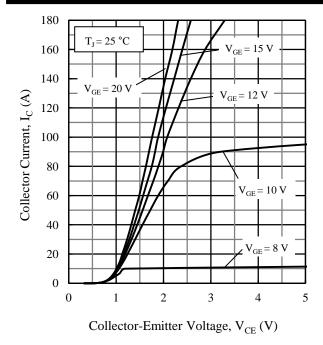


Figure 6. Output Characteristics ( $T_J = 25$  °C)

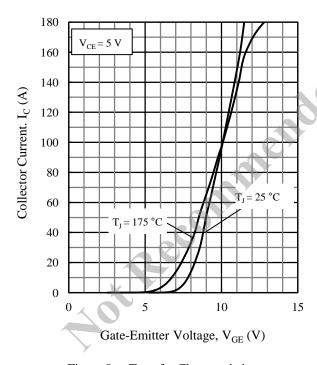


Figure 8. Transfer Characteristics

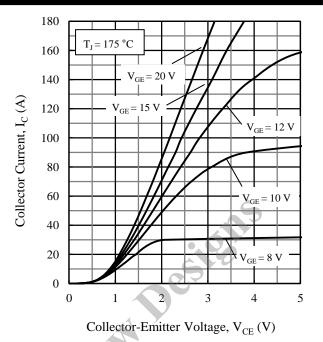


Figure 7. Output Characteristics ( $T_J = 175$  °C)

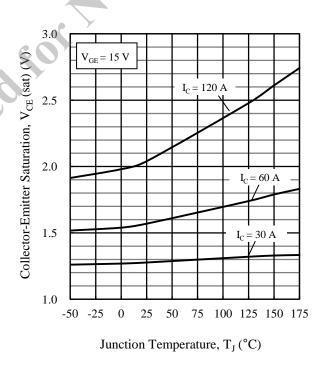


Figure 9. Saturation Voltage vs. Junction Temperature

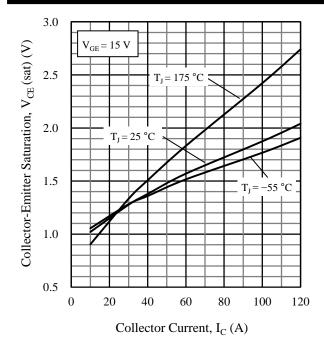


Figure 10. Saturation Voltage vs. Collector Current

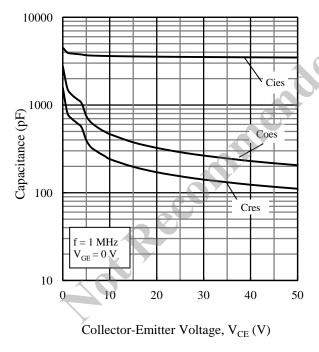
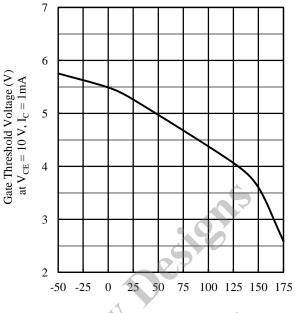


Figure 12. Capacitance Characteristics



Junction Temperature,  $T_J$  (°C)

Figure 11. Gate Threshold Voltage vs. Junction Temperature

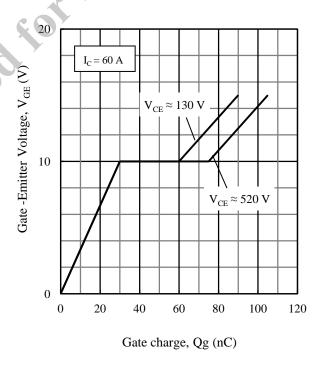


Figure 13. Typical Gate Charge

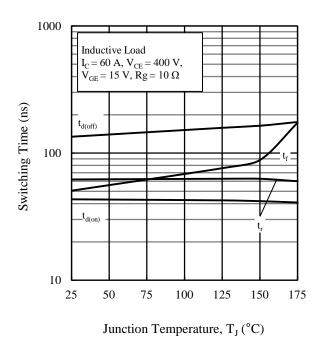


Figure 14. Switching Time vs. Junction Temperature

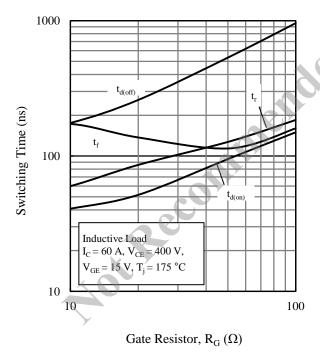


Figure 16. Switching Time vs. Gate Resistor

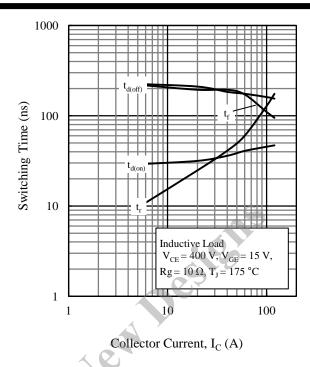


Figure 15. Switching Time vs. Collector Current

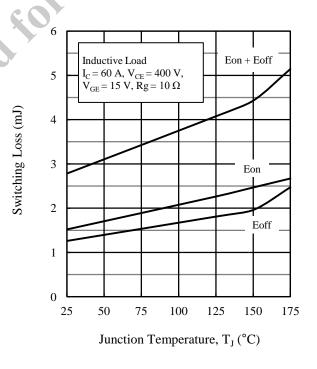


Figure 17. Switching Loss vs. Junction Temperature

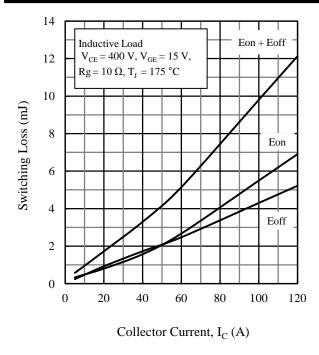


Figure 18. Switching Loss vs. Collector Current

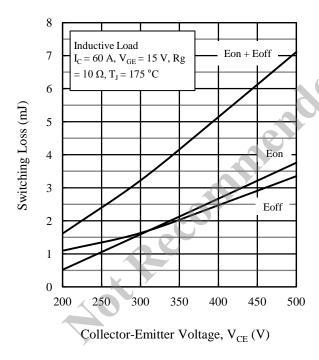


Figure 20. Switching Loss vs. Collector-Emitter Voltage

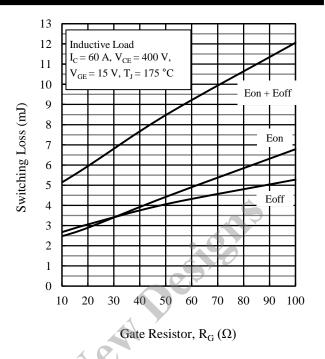


Figure 19. Switching Loss vs. Gate Resistor

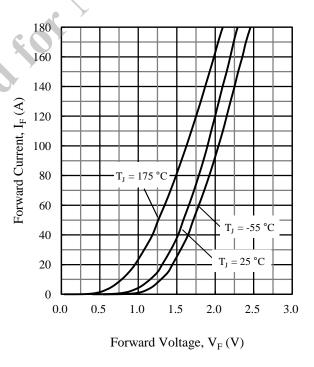


Figure 21. Diode Forward Characteristics

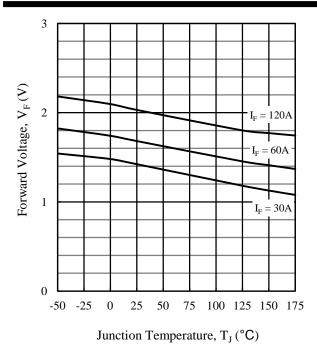


Figure 22. Diode Forward Voltage vs. Junction Temperature

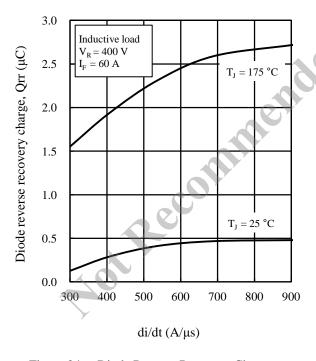


Figure 24. Diode Reverse Recovery Charge vs.  $\frac{di}{dt}$ 

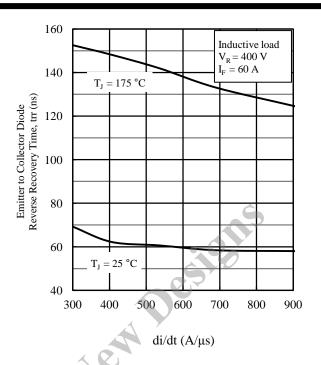


Figure 23. Diode Reverse Recovery Time vs. di/dt

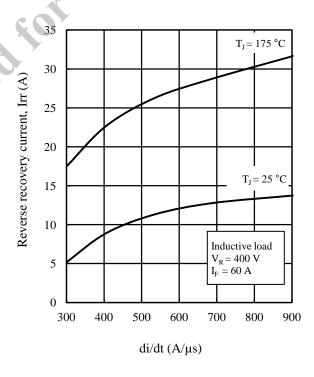
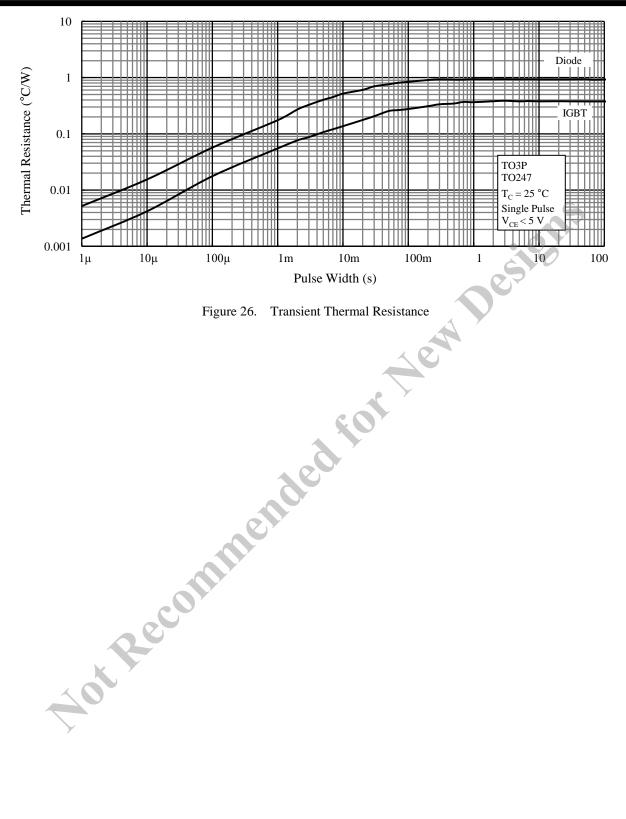
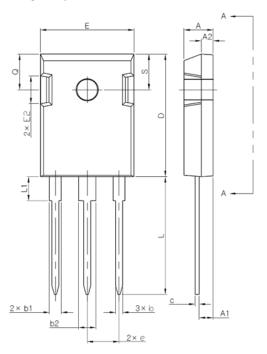


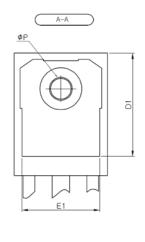
Figure 25. Diode Reverse Recovery Current vs. di/dt



# **Physical Dimensions**

#### • TO247-3L

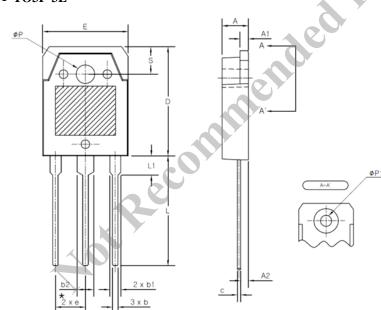




SYMBOL	MIN	NOM	MAX	
Α	4.83	5.02	5.21	
A1	2.29	2.41	2.54	
A2	1.91	2.04	2.16	
b	1.14	1.27	1.40	
b1	1.91	2.10	2.20	
b2	2.92	3.10	3.20	
С	0.61	0.71	0.80	
D	20.80	21.07	21.34	
D1	17.43	17.63	17.83	
Е	15.75	15.94	16.13	
E1	13.06	13.26	13.46	
E2	4.32	4.58	4.83	
е	5.25	5.45	5.65	
L	19.81	20.19	20.57	
L1	3.81	4.07	4.32	
ØΡ	3.55	3.60	3.65	
Q A	5.59	5.90	6.20	
S	6.15 BSC			
		·		

NOTE THESE DIMENSION DO NOT INCLUDE MOLD PROTRUSION

#### • TO3P-3L



SYMBOL	MIN	NOM	MAX
Α	4.60	4.80	5.00
A1	1.45	1.50	1.65
A2	1.20	1.40	1.60
b	0.80	1.00	1.20
b1	1.80	2.00	2.20
b2	2.80	3.00	3.20
С	0.55	0.60	0.75
D	19.70	19.90	20.10
E	15.40	15.60	15.80
* <sub>e</sub>	5.25	5.45	5.65
L	19.80	20.00	20.20
L1	3.30	3.50	3.70
ØΡ	3.30	3.40	3.50
ØP1	3.10	3.20	3.30
S	4.80	5.00	5.20

NOTE 1. THESE DIMENSIONS DO NOT INCLUDE PROTRUSIONS OF THE MOLD. 2. THE "( )" MARK IS THE REFERENCE

#### **NOTES:**

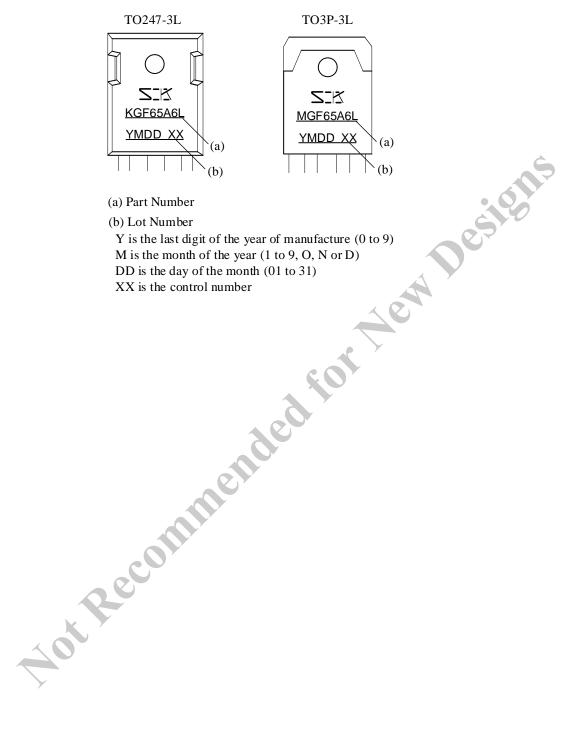
- All dimensions in millimeters
- Pin treatment for TO247 and TO3P: Pb-free (RoHS compliant)
- When soldering the products, make sure to minimize the working time within the following limits:

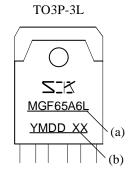
 $260 \pm 5$  °C  $10 \pm 1$  s, 2 times (flow)

 $380 \pm 10$  °C  $3.5 \pm 0.5$  s, 1 time (soldering iron)

- Soldering should be at a distance of at least 1.5 mm from the body of the products.
- The recommended screw torque for TO247, TO3P and TO3PF: 0.686 to 0.882 N·m (7 to 9 kgf·cm)

# **Marking Diagram**





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DSGN-AEZ-16002